AN13940 Connect i.MX RT1060 to USB 4G Module (RNDIS Mode) Rev. 0 — 18 April 2023

Application note

Document Information

| Information | Content |
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| Keywords | i.MX RT, RT, USB, 4G, LTE |
| Abstract | This application note discusses how to connect i.MX RT1060 EVK to Internet by USB 4G module like EC200A-CN from Quectel. |



1 Introduction

There is one SDK example **evkbmimxrt1060_lwip_dhcp_usb_bm** in the i.MX RT1060 EVK SDK. It connects the USB to the Internet with the three cell phones mentioned in the guide. But if customer wants to use a USB 4G module, instead of a cell phone listed in the guide, to connect to the Internet, and it is possible that this example cannot work in such condition. Then we must adapt this example to new USB 4G module.

This application note discusses how to implement the adaption when the terminal becomes a USB 4G module like EC200A-CN from Quectel, and then connect to the Internet with this USB 4G module.

2 Basics

2.1 Introduction of RNDIS

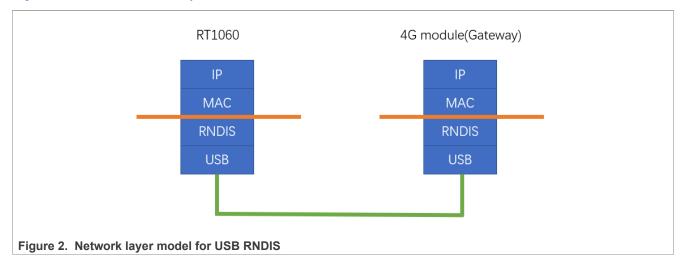
Remote Network Driver Interface Specification (RNDIS) is a USB protocol defined by Microsoft. The windows OS can recognize the USB device which follows this specification automatically and treat it as a network device, as shown in Figure 1.

| Name | Status | Device Name | Connectivity | Network Categor |
|---------------------|-------------------------|---------------------------------------|--------------------|-----------------|
| 8 Bluetooth Network | Not connected | Bluetooth Device (Personal Area Net | | |
| 📶 Wi-Fi | wbi.nxp.com | Intel(R) Dual Band Wireless-AC 8265 | Internet access | Domain network |
| 🥏 Ethernet | Network cable unplugged | Intel(R) Ethernet Connection (4) I219 | | |
| 🥏 Ethernet 2 | Identifying | Remote NDIS based Internet Sharing | No Internet access | Public network |

Figure 1. USB 4G module connected to windows

2.2 Network layer model for USB RNDIS

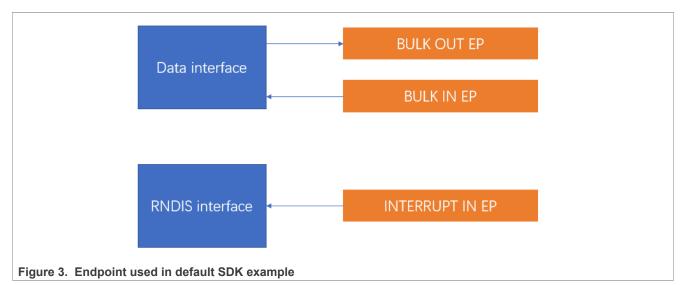
Figure 2 shows the network layer model for USB RNDIS.



2.3 RNDIS interface/endpoint analysis

In the original SDK example, it uses two interfaces and three endpoints.

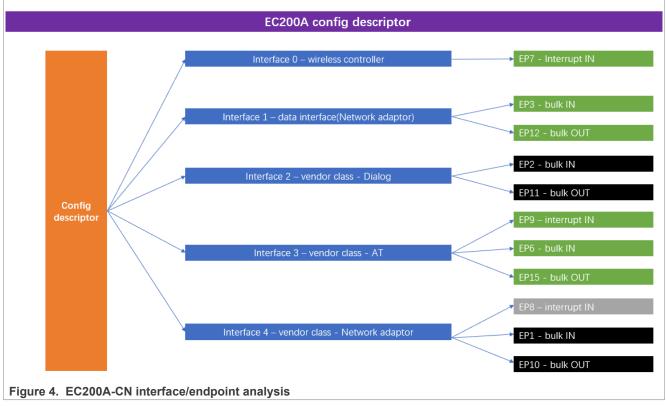
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Here, the data interface is used for Ethernet package communication, and there is one endpoint for each direction. RNDIS interface is used for device status polling.

2.4 EC200A-CN interface/endpoint analysis

EC200A-CN implements five interfaces, which include the interfaces introduced above.



The additional interface used here is the AT interface.

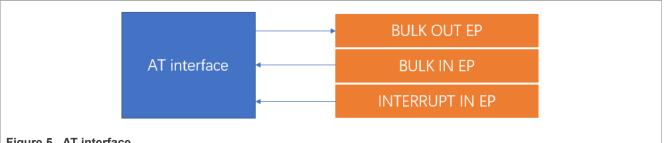


Figure 5. AT interface

The AT interface is used to dial (send AT command and get response), poll, and control the USB 4G module. We need poll the USB 4G module status and send the command to it to set it to the online mode. Then, the IP package from/to RT1060 EVK can be sent to/received from the Internet.

To enable/adapt to the new 4G module, we must:

• Enable AT interface

· Dial on AT interface

The other interfaces defined by the EC200A-CN are not important for us here, so they are not introduced in this document.

2.5 Some basics for USB host application by NXP SDK

• NXP SDK USB stack decodes the configuration descriptor automatically. It can detect all the interfaces and endpoints in the configuration descriptor.

See USB HostParseDeviceConfigurationDescriptor() in usb/host/usb host devices.c. Figure 6 shows the related call stack. Call stack analysis is useful for us to understand how the SDK USB stack is organized.

| 1 | USB_HostParseDeviceConfigurationDescriptor() at |
|-----------------------------------|--|
| - | USB_HostProcessCallback() at usb_host_devices.c: |
| 1 | USB_HostEnumerationTransferCallback() at usb_h |
| 1 | USB_HostEhciTransactionDone() at usb_host_ehci. |
| 1 | USB_HostEhciTaskFunction() at usb_host_ehci.c:5,(|
| 1 | ■ USB_HostTaskFn() at lwip_dhcp_usb_bm.c:137 0x€ |
| 1 | USB_HostApplicationInit() at usb_ethernetif_bm.c: |
| 1 | USB_EthernetIfInIt() at usb_ethernetif_bm.c:382 0x |
| 1 | ■ netif_add() at netif.c:388 0x6000c504 |
| 1 | ■ main() at lwip_dhcp_usb_bm.c:279 0x60006da4 |
| gure 6. Call stack for USB HostPa | rseDeviceConfigurationDescriptor() |
| _ | |

• For the event callback, see USB HostEvent () in Iwip/port/usb ethernetif bm.c. Figure 7 shows the related call stack.

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| | ≡ USB HostEvent() at usb ethernetif bm.c:312 0x60012f78 |
|---------------------|--|
| | ■ USB HostNotifyDevice() at usb host devices.c:609 0x60017c4c |
| | ■ USB_HostProcessCallback() at usb_host_devices.c:535 0x60004c4a |
| | USB_HostEnumerationTransferCallback() at usb_host_devices.c:239 0x600047ce |
| | USB_HostEhciTransactionDone() at usb_host_ehci.c:3,926 0x600192b8 |
| | USB_HostEhciTaskFunction() at usb_host_ehci.c:5,058 0x60019b2e |
| | USB_HostTaskFn() at lwip_dhcp_usb_bm.c:137 0x6001a692 |
| | USB_HostApplicationInit() at usb_ethernetif_bm.c:360 0x60013044 |
| | USB_EthernetIfInIt() at usb_ethernetif_bm.c:382 0x600130ca |
| | ≡ netif_add() at netif.c:388 0x6000c504 |
| Figure 7. Call stac | k for USB_ HostEvent () |

• Open pipe for each interface.

See USB_HostCdcOpenDataInterfac() and USB_HostCdcOpenControlInterface() in usb_host_cdc.c.

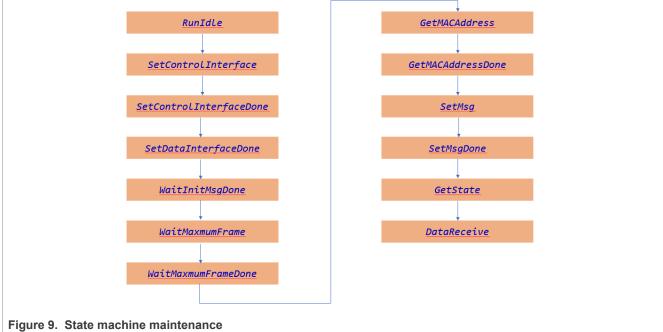
Figure 8 shows the related call stack.

- USB_HostCdcOpenDataInterface() at usb_host_cdc.c:339 0x60002836
- USB_HostCdcSetDataInterface() at usb_host_cdc.c:838 0x60002dbe
- USB_HosCdcRndisTask() at usb_ethernetif_bm.c:844 0x60013940
- USB_HostApplicationInit() at usb_ethernetif_bm.c:361 0x6001304a
- USB_EthernetIfInIt() at usb_ethernetif_bm.c:382 0x600130ca
- netif_add() at netif.c:388 0x6000c504
- main() at lwip_dhcp_usb_bm.c:279 0x60006da4

Figure 8. Call stack for USB_ HostCdcOpenDataInterfac ()

State machine maintenance

For state machine maintenance, refer to USB_HosCdcRndisTask() and USB_HostCdcRndisControlCallback() in *lwip/port/usb_ethernetif_bm.c*. Figure 9 shows the default state machine. Adjust it to enable the AT interface and dial on AT interface.



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3 Details for implementation

Based on the introduction above, this section discusses the implementation details. Some code is presented here. For more details, see AN13940SW.

The main code changes are in:

- usb_ethernet_bm.c
- usb_ethernet.h

Some key code changes include:

• Add the data structure for AT interface. It is in *sdk_root\/wip\port\usb_ethernetif.h*.

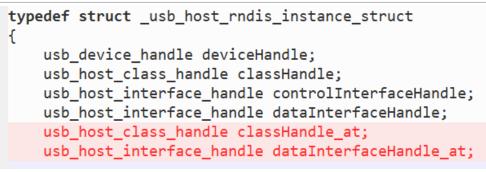


Figure 10. Add the data structure for AT interface

• Add class initial code in attach event. It is in *lwip\port\usb ethernetif bm.c.*

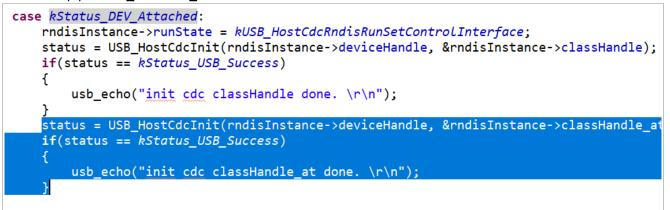


Figure 11. Add class initial code

• Add de-init code in de-attach event. It is in *lwip\port\usb_ethernetif_bm.c*.

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```
case kStatus_DEV_Detached:
    rndisInstance->deviceState = kStatus_DEV_IdLe;
    rndisInstance->runState = kUSB_HostCdcRndisRunIdLe;
    USB_HostCdcDeinit(rndisInstance->deviceHandle, rndisInstance->classHandle);
    USB_HostCdcDeinit(rndisInstance->deviceHandle, rndisInstance->classHandle_at);
    rndisInstance->classHandle = NULL;
    rndisInstance->controlInterfaceHandle = NULL;
    rndisInstance->dataInterfaceHandle = NULL;
    rndisInstance->classHandle_at = NULL;
    rndisInstance->classHandle_at = NULL;
    rndisInstance->dataInterfaceHandle_at = NULL;
    rndisInstance->dataInterfaceHandle_at = NULL;
    rndisInstance->deviceHandle = NULL;
    rndisInstance->deviceHandle = NULL;
    rndisInstance->interruptRunState = kUSB_HostCdcRndisRunIdLe;
    usb_echo("rndis device detached\r\n");
    break;
```

Figure 12. Add de-init code in de-attach event

• Update the state machine enum variable. It is in *lwip\port\usb ethernetif.h.*

| 1 1 1 1 1 1 1 1 1 1 | | |
|---------------------------------|--|--|
| | typedef enum HostCdcRndisRunState | |
| | <pre>kUSB_HostCdcRndisRunIdle = 0,</pre> | |
| | kUSB_HostCdcRndisRunSetControlInterface, kUSB_HostCdcRndisRunWaitSetControlInterface, kUSB_HostCdcRndisRunSetControlInterfaceDone, | |
| | kUSB_HostCdcRndisRunSetDataInterface, kUSB_HostCdcRndisRunWaitSetDataInterface, kUSB_HostCdcRndisRunSetDataInterfaceDone, | |
| | kUSB_HostCdcRndisRunSetATDataInterface, kUSB_HostCdcRndisRunWaitSetATDataInterface, kUSB_HostCdcRndisRunSetATDataInterfaceDone, | |
| | <pre>kUSB_HostCdcRndisRunWaitInitMsg, kUSB_HostCdcRndisRunWaitInitMsgDone, kUSB_HostCdcRndisRunWaitGetMACAddress, kUSB_HostCdcRndisRunWaitGetMACAddressDone,</pre> | |
| | kUSB_HOStCdcRndisRunWaitGetrACAddressDone, kUSB_HostCdcRndisRunWaitMaxmumFrame, kUSB_HostCdcRndisRunWaitSetMsg, kUSB_HostCdcRndisRunWaitSetMsg, | |
| | // kUSB_HostCdcRndisRunEC200AInit, kUSB_HostCdcRndisRunWaitEC200AInit, | |
| | kUSB_HostCdcRndisRunEC200AInitDone, | |
| | <pre>// kUSB_HostCdcRndisRunDial, kUSB_HostCdcRndisRunWaitDial, kUSB HostCdcRndisRunDialDone,</pre> | |
| Figure 13. Update state machine | | |

• Update state machine implementation function. It is in *lwip\port\usb_ethernetif_bm.c*.

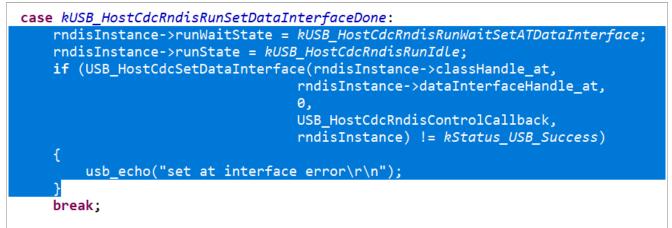


Figure 14. Update state machine implementation function

 Add related API and callback. The function parameter is not displayed here. For more details, see AN13940SW.

```
USB_HostCdcRndisATInCallback();
USB_HostCdcRndisATOutCallback();
dial_tx(); // Send command on AT interface
dial_rx(); // Receive message from AT interface
lte_dial(); // Dial, then USB 4G module can connect to internet
USB_HostCdcRndisEC200ACallback();
ep0_communicate(); // API used for AT interface enablement, to send/receive
command/message to/from EP0
init_ec200a(); // Initiate EC200A, then AT interface communication is available
```

• The maximum interfaces number is supported.

The maximum interfaces number is different when connected to different USB 4G module. The update is required.

For example, if using the LE910C1-EU, update the value to 8.

#define USB_HOST_CONFIG_CONFIGURATION_MAX_INTERFACE (8U)

 Figure 15. Maximum interfaces number supported

 And for EC200A-CN used in this document, the default value, 5, can work directly.

• Implement the new state machine for AT interface enablement and dial on AT interface. The main code change is in function USB_HostCdcRndisControlCallback() and USB_HosCdcRndisTask() in *lwip\port\usb_ethernetif_bm.c.* For more details, see AN13940SW.

· Adapt AT interface.

The AT data interface index is decoded from USB analyzer when connecting the USB 4G module to a PC. The code is from USB_HostCdcRndisEvent() in *lwip\port\usb_ethernetif_bm.c*, it assigns interfaceList[3] to the g_RndisInstance, dataInterfaceHandle_at, and implements the binding.

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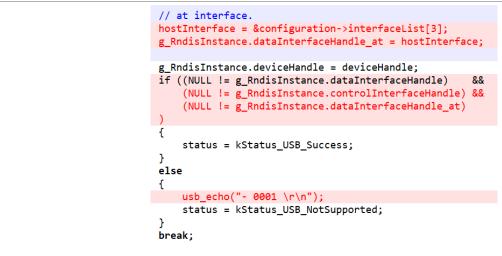


Figure 16. Bind AT interface

Run the code after all code changes, and we can see that the i.MX RT1060 EVK is connected to the Internet successfully with USB 4G module EC200A-CN.

Connect i.MX RT1060 to USB 4G Module (RNDIS Mode)

+QIND: PB DONE ec200a_rx_index = 3 PB DONE detected. dial_state = 100. AT+qnetdevctl=1, 1, 1 >>>TX: AT+qnetdevctl=1, 1, 1 dial_state = 101. >>RX: AT+qnetdevctl=1,1,1 ec200a_rx_index = 4 $dial_state = 102.$ >>>RX : OK tdevctl=1, 1, 1 ec200a_rx_index = 5 dial_state = 103. >>>RX: +QNETDEVSTATUS: 1 ec200a_rx_index = 6 end do not need to rx again. dial done. DHCP example DHCP state : SELECTING DHCP state : REQUESTING DHCP state : BOUND : 192.168.43.100 IPv4 Address IPv4 Subnet mask : 255.255.255.0 IPv4 Gateway : 192.168.43.1 waiting for getting the IP Address.... the IP Address of nxp. com is : 223.119.214.147 ping: send 223.119.214.147 ping: recv 223. 119. 214. 147 60 ms

Figure 17. Connect to the Internet with USB 4G module EC200A-CN

4 Attention

Make sure that the power supply is enough for USB 4G module. In this case, the i.MX RT1060 EVK is powered with an external power adapter, instead of with a USB cable. Otherwise, the USB 4G module resets when it tries to enable the RF to connect to the Internet.

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5 Conclusion

This application note discusses the basic knowledge and details about how to connect i.MX RT1060 EVK to the Internet by USB 4G module EC200A-CN. It can be helpful for user reference when they want to connect to the Internet with the same or other USB 4G modules.

Connect i.MX RT1060 to USB 4G Module (RNDIS Mode)

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Date of release: 18 April 2023 Document identifier: AN13940